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--17. (new) The electrode structure according to claim 16, wherein the electrode structure is cylindrical having a concentric cylindrical hollow portion thereinside, said circumferential wall surface surrounding said hollow portion, and a flange portion, and wherein said cylindrical hollow portion fits into a cylindrical recess provided on an outer surface of said carrier substrate of said semiconductor device, and said electrode structure is fixedly attached to said carrier substrate so that said flange portion abuts said outer surface of said carrier substrate.

--18. (new) The electrode structure according to claim 17, wherein said through portion is at least one slit in said flange portion and on said cylindrical circumferential wall surface adjacent to said flange portion, said slit extending from said flange portion to a position adjacent a bottom of said cylindrical circumferential wall surface.--

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Please charge the fee of \$84 for the addition of one extra independent claim(s), added herewith, to Deposit Account No. 25-0120.

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